

# **RESX07-1U22F**

22" Deep, Front I/O Rugged Rack Server

Low-latency, high-throughput rugged rack server

- Dual Intel® 3rd generation Xeon®
  Scalable processors up to 36 cores
- Designed, tested and manufactured in the U.S.
- Configurable up to 6 expansion slots that support 1 NVIDIA A100 GPLI
- Memory up to 20 DIMM slots



#### **TECHNICAL SPECIFICATIONS**

Dual Intel 3rd generation Xeon Scalable processors

3 UPI links up to 11.2 GT/s

 $20 \, \text{DIMM}$  slots, up to 2,560 GB DDR4-  $3200 \, \text{MHz}$ 

Intel Trusted Execution Technology (TXT) with integrated TPM 2.0

# **Management and Operating System**

Windows, Linux OS

Contact factory for OpenBMC

IPMI 2.0 management

# Expansion and Modular Maintainability

Up to 6 expansions slots:

- Slot 1: PCle gen 4.0 dual-width x16 FHFL, up to 12" w/ FIO
- Slot 2: PCle gen 4.0 single-width x16 FHFL, up to 7.5" w/ no IO
- Slot 3: PCle gen 4.0 single-width x16 FHFL, up to 7.5" w/ RIO
- Slot 4: PCle gen 4.0 single-width x16 HHFL, up to 7.0" w/ FI0
- Slot 5: PCle gen 4.0 single-width x8 HHFL, up to 7.5" w/ FIO
- Slot 6: OCP3.0 PCle gen 4.0 x16 w/ FI0

Up to 2 NVMe M.2 slots

# **Power Supply Options**

Non-redundant AC and DC power options:

- 1000 W 120 VAC
- 1300 W 240 VAC
- 1000 W 48 VDC
- 750 W 28 VDC

## Environmental\*

#### Operating

Temperature: 0°C to 50°C, configuration dependent

Humidity: 5% - 90%, up to 50°C, non-condensing

Shock: 3 axis, 35 g, 25 ms

Vibration: 4.7 Grms vertical, 4.5 Grms longitudinal, 5 Hz to 2000 Hz

## Non-Operating

Temperature: -40°C to 70°C, configuration dependent

Humidity: 5% to 90%, up to  $50^{\circ}$ C, non-condensing

# **Additional Options**

Shock pins

Slide rails

Cable accessories

Partnering with









## Mechanical

Height: 1U or 1.75" (44.45 mm) Width: 17.36" (440.9 mm)

Depth: 22" (558.8 mm) from front to back, 21" (533.4 mm) from ear to back

Weight (Typical)\*: 27 lb

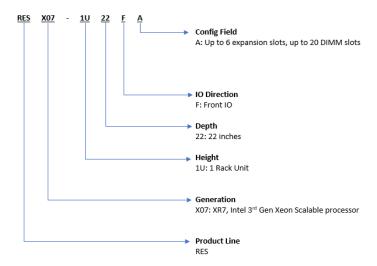
# 19" rackmountable

\* Mercury Systems designs all products to meet or exceed listed data sheet specifications. Some specifications including I/O profiles, weight and thermal profiles are configuration dependent. Contact Mercury for information specific to your desired configuration requirements.



Front View

# **Product Naming Chart**



# mercury

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